LM565/LM565C Phase Locked Loop

Check for Samples: LM565, LM565C

FEATURES

- 200 ppm/°C Frequency Stability of the VCO
- Power Supply Range of ±5 to ±12 Volts with
  100 ppm/% Typical
- 0.2% Linearity of Demodulated Output
- Linear Triangle Wave with in Phase Zero
  Crossings Available
- TTL and DTL Compatible Phase Detector Input
  and Square Wave Output
- Adjustable Hold in Range from ±1% to > ±60%

APPLICATIONS

- Data and Tape Zynchronization
- Modems
- FSK Demodulation
- FM Demodulation
- Frequency Synthesizer
- Tone Decoding
- Frequency Multiplication and Division
- SCA Demodulators
- Telemetry Receivers
- Signal Regeneration
- Coherent Demodulators

DESCRIPTION

The LM565 and LM565C are general purpose phase locked loops containing a stable, highly linear voltage controlled oscillator for low distortion FM demodulation, and a double balanced phase detector with good carrier suppression. The VCO frequency is set with an external resistor and capacitor, and a tuning range of 10:1 can be obtained with the same capacitor. The characteristics of the closed loop system—bandwidth, response speed, capture and pull in range—may be adjusted over a wide range with an external resistor and capacitor. The loop may be broken between the VCO and the phase detector for insertion of a digital frequency divider to obtain frequency multiplication.

The LM565H is specified for operation over the −55°C to +125°C military temperature range. The LM565CN is specified for operation over the 0°C to +70°C temperature range.

Connection Diagram

TO-100 Package

See Package Number LME

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.
Absolute Maximum Ratings (1)(2)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Conditions</th>
<th>LM565</th>
<th>LM565C</th>
<th>Units</th>
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<td>Supply Voltage</td>
<td>±12V</td>
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<tr>
<td>Power Dissipation (3)</td>
<td>1400 mW</td>
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<tr>
<td>Differential Input Voltage</td>
<td>±1V</td>
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<tr>
<td>Operating Temperature Range</td>
<td>LM565H</td>
<td>−55°C to +125°C</td>
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<tr>
<td></td>
<td>LM565CN</td>
<td>0°C to +70°C</td>
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<tr>
<td>Storage Temperature Range</td>
<td>−65°C to +150°C</td>
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<td>Lead Temperature (Soldering, 10 sec.)</td>
<td>260°C</td>
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</table>

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which ensure specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not ensured for parameters where no limit is given, however, the typical value is a good indication of device performance.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

(3) The maximum junction temperature of the LM565 and LM565C is +150°C. For operation at elevated temperatures, devices in the TO-5 package must be derated based on a thermal resistance of +150°C/W junction to ambient or +45°C/W junction to case. Thermal resistance of the dual-in-line package is +85°C/W.

Electrical Characteristics

AC Test Circuit, $T_A = 25°C, V_{CC} = ±6V$

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<tr>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
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<td>Power Supply Current</td>
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<td>8.0</td>
<td>12.5</td>
<td></td>
<td>8.0</td>
<td>12.5</td>
<td></td>
<td>mA</td>
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<td>Input Impedance (Pins 2, 3)</td>
<td></td>
<td>7</td>
<td>10</td>
<td>5</td>
<td>5</td>
<td></td>
<td></td>
<td>kΩ</td>
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<tr>
<td>VCO Maximum Operating Frequency</td>
<td>$C_o = 2.7 \mu F$</td>
<td>300</td>
<td>500</td>
<td>250</td>
<td>500</td>
<td></td>
<td>kHz</td>
<td></td>
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<tr>
<td>VCO Free-Running Frequency</td>
<td>$C_o = 1.5 \mu F, R_o = 20 \Omega, f_o = 10 kHz$</td>
<td>−10</td>
<td>0</td>
<td>+10</td>
<td>−30</td>
<td>0</td>
<td>+30</td>
<td>%</td>
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<td>Operating Frequency Temperature Coefficient</td>
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<td>−100</td>
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<td>−200</td>
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<td>Frequency Drift with Supply Voltage</td>
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<td>0.1</td>
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<td></td>
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<td>1.5</td>
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<td>%/V</td>
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<td>Triangle Wave Output Voltage</td>
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<td>2</td>
<td>2.4</td>
<td>3</td>
<td>2</td>
<td>2.4</td>
<td>3</td>
<td>V_p-p</td>
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<td>Triangle Wave Output Linearity</td>
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<td>0.2</td>
<td></td>
<td>0.5</td>
<td></td>
<td></td>
<td></td>
<td>%</td>
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<tr>
<td>Square Wave Output Level</td>
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<td>4.7</td>
<td>5.4</td>
<td></td>
<td>4.7</td>
<td>5.4</td>
<td></td>
<td>V_p-p</td>
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<td>Output Impedance (Pin 4)</td>
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<td>5</td>
<td></td>
<td>5</td>
<td></td>
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<td>kΩ</td>
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<td>Square Wave Duty Cycle</td>
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<td>45</td>
<td>50</td>
<td>55</td>
<td>40</td>
<td>50</td>
<td>60</td>
<td>%</td>
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<td>Square Wave Rise Time</td>
<td></td>
<td>20</td>
<td></td>
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<td>Square Wave Fall Time</td>
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<td>50</td>
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<td>Output Current Sink (Pin 4)</td>
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<td>0.6</td>
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<td>0.6</td>
<td>1</td>
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<td>mA</td>
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<tr>
<td>VCO Sensitivity</td>
<td>$f_o = 10 kHz$</td>
<td>6600</td>
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<td>6600</td>
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<td>Hz/V</td>
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<td>Demodulated Output Voltage (Pin 7)</td>
<td>±10% Frequency Deviation</td>
<td>250</td>
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<td>400</td>
<td>200</td>
<td>300</td>
<td>450</td>
<td>mV_p-p</td>
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<td>Total Harmonic Distortion</td>
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<td>0.2</td>
<td>0.75</td>
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<td>%</td>
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<td>Output Impedance (Pin 7)</td>
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<td>3.5</td>
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<td>3.5</td>
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<td></td>
<td>kΩ</td>
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<td>DC Level (Pin 7)</td>
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<td>4.25</td>
<td>4.5</td>
<td>4.75</td>
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<td>5.0</td>
<td>V</td>
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<td>Output Offset Voltage</td>
<td>$</td>
<td>V_7 - V_6</td>
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<td>30</td>
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<td>50</td>
<td>200</td>
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<td>Temperature Drift of $</td>
<td>V_7 - V_6</td>
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<td>AM Rejection</td>
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<td>Phase Detector Sensitivity $K_D$</td>
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<td>0.68</td>
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<td></td>
<td></td>
<td>V/radian</td>
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</table>
Typical Performance Characteristics

- Figure 1: Power Supply Current as a Function of Supply Voltage
- Figure 2: Lock Range as a Function of Input Voltage
- Figure 3: VCO Frequency vs Timing Resistor
- Figure 4: Oscillator Output Waveforms
- Figure 5: Phase Shift vs VCO Frequency
- Figure 6: VCO Frequency as a Function of Temperature
Typical Performance Characteristics (continued)

Loop Gain vs Load Resistance

Hold in Range as a Function of $R_{6-7}$

Figure 7.

Figure 8.
Figure 9. Schematic Diagram
Note: \( S_1 \) open for output offset voltage \((V_7 - V_6)\) measurement.

Figure 10. AC Test Circuit
Typical Applications

Figure 11. 2400 Hz Synchronous AM Demodulator
Figure 12. FSK Demodulator (2025–2225 cps)

Figure 13. FSK Demodulator with DC Restoration
Figure 14. Frequency Multiplier (×10)

Figure 15. IRIG Channel 13 Demodulator
APPLICATIONS INFORMATION

In designing with phase locked loops such as the LM565, the important parameters of interest are:

FREE RUNNING FREQUENCY

\[ f_0 \approx \frac{0.3}{R_0C_0} \]  

(1)

LOOP GAIN: relates the amount of phase change between the input signal and the VCO signal for a shift in input signal frequency (assuming the loop remains in lock). In servo theory, this is called the “velocity error coefficient.”

\[
\text{Loop gain} = K_o K_D \left( \frac{1}{\text{sec}} \right)
\]

(2)

\[ K_o = \text{oscillator sensitivity} \left( \frac{\text{radians/sec}}{\text{volt}} \right) \]

\[ K_D = \text{phase detector sensitivity} \left( \frac{\text{volts}}{\text{radian}} \right) \]

The loop gain of the LM565 is dependent on supply voltage, and may be found from:

\[
K_o K_D = \frac{33.6 f_0}{V_c}
\]

(3)

\[ f_0 = \text{VCO frequency in Hz} \]

\[ V_c = \text{total supply voltage to circuit} \]

Loop gain may be reduced by connecting a resistor between pins 6 and 7; this reduces the load impedance on the output amplifier and hence the loop gain.

HOLD IN RANGE: the range of frequencies that the loop will remain in lock after initially being locked.

\[ f_H = \pm \frac{8 f_0}{V_c} \]

(4)

where

- \( f_0 \) = free running frequency of VCO
- \( V_c \) = total supply voltage to the circuit

THE LOOP FILTER

In almost all applications, it will be desirable to filter the signal at the output of the phase detector (pin 7); this filter may take one of two forms:

**Figure 16. Simple Lead Filter**

**Figure 17. Lag-Lead Filter**
A simple lag filter may be used for wide closed loop bandwidth applications such as modulation following where the frequency deviation of the carrier is fairly high (greater than 10%), or where wideband modulating signals must be followed.

The natural bandwidth of the closed loop response may be found from:

$$f_n = \frac{1}{2\pi} \sqrt{\frac{K_0 K_D}{R_1 C_1}}$$

(5)

Associated with this is a damping factor:

$$\delta = \frac{1}{2} \sqrt{\frac{1}{R_1 C_1 K_0 K_D}}$$

(6)

For narrow band applications where a narrow noise bandwidth is desired, such as applications involving tracking a slowly varying carrier, a lead lag filter should be used. In general, if $1/R_1 C_1 < K_0 K_D$, the damping factor for the loop becomes quite small resulting in large overshoot and possible instability in the transient response of the loop. In this case, the natural frequency of the loop may be found from

$$f_n = \frac{1}{2\pi} \sqrt{\frac{K_0 K_D}{\tau_1 + \tau_2}}$$

$$\tau_1 + \tau_2 = (R_1 + R_2) C_1$$

(7)

$R_2$ is selected to produce a desired damping factor $\delta$, usually between 0.5 and 1.0. The damping factor is found from the approximation:

$$\delta \approx \pi \tau_{df}$$

(8)

These two equations are plotted for convenience.

Capacitor $C_2$ should be much smaller than $C_1$ since its function is to provide filtering of carrier. In general $C_2 \leq 0.1 C_1$. 

Figure 18. Filter Time Constant vs Natural Frequency

Figure 19. Damping Time Constant vs Natural Frequency
## REVISION HISTORY

### Changes from Revision A (April 2013) to Revision B

<table>
<thead>
<tr>
<th>Change Description</th>
<th>Page</th>
</tr>
</thead>
<tbody>
<tr>
<td>Changed layout of National Data Sheet to TI format</td>
<td>12</td>
</tr>
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</table>
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